

100V N-Channel Power MOSFET

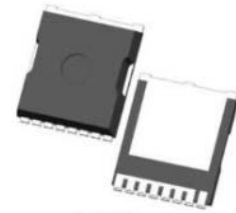
DESCRIPTION :

- High Speed Power Switching
- Enhanced Body diode dv/dt capability
- Enhanced Avalanche Ruggedness
- 100% UIS Tested, 100% Rg Tested
- RoHS compliant
- Halogen Free

V_{DS}	100V
$I_D(T_c = 25^\circ\text{C})$	290A
$R_{DS(on)} @ V_{GS}=10V \text{ (Max)}$	2m Ω

TYPICAL APPLICATIONS :

- DC/DC in Telecoms and Industrial
- Power management
- Portable Equipment



TOLL

MAXIMUM RATINGS (at $T_J = 25^\circ\text{C}$, unless otherwise specified)

Characteristic	Condition	Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_c=25^\circ\text{C}$ $T_c=100^\circ\text{C}$	I_D	290 160	A
Maximum power dissipation	$T_c=25^\circ\text{C}$	P_D	312	W
Single Pulse Avalanche Current	0.5mH	E_{AS}	1225	mJ
Operation Junction temperature		T_{jmax}	150	$^\circ\text{C}$
Storage temperature		T_{STG}	-55~+150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Condition	Symbol	Value	Unit
Thermal resistance, junction - Ambient		$R_{\theta(j-A)}$	60	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS (at $T_J = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage VGS = 0V, ID = 250uA	BV _{DSS}	100			V
Zero Gate Voltage Drain Current VDS = 100 V, VGS = 0 V Tj=25°C VDS = 100 V, VGS = 0 V Tj=100°C	IDSS			1 100	uA
Gate-Source Leakage Current VGS = ±20V, VDS = 0V	IGSS			±100	nA
Gate-Source Threshold Voltage VDS = VGS, ID = 250uA	VGS(th)	2.8		4.5	V
Drain-Source On-State Resistance VGS = 10V, ID = 50A	RDS(on)			2	mΩ
Snput capacitance f=1MHz, VDS=50 V, VGS=0 V	C _{iss}		6554		pF
Output capacitance f=1MHz, VDS=50 V, VGS=0 V	C _{oss}		4855		pF
Reverse transfer capacitance f=1MHz, VDS=50 V, VGS=0 V	C _{rss}		309		pF
Total Gate Charge VDS= 50V, ID= 20A, VGS= 10V	QG		122		nC
Gate to Source Charge VDS= 50V, ID= 20A, VGS= 10V	QGS		37		nC
Gate to Drain Charge VDS= 50V, ID= 20A, VGS= 10V	QGD		27		nC
Turn-on delay time VDS=50 V, ID=20A, VGS= 10V, RG=5Ω	td _(ON)		25		ns
Rise time VDS=50 V, ID=20A, VGS= 10V, RG=5Ω	tr		33		ns
Turn-off delay time VDS=50 V, ID=20A, VGS= 10V, RG=5Ω	td _(OFF)		95		ns
Fall time VDS=50 V, ID=20A, VGS= 10V, RG=5Ω	tf		75		ns

Body DiodeELECTRICAL CHARACTERISTICS (at $T_J = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Diode Forward Voltage $V_{GS} = 0V, I_F = 50A \quad T_J = 25^\circ\text{C}$	V_{SD}		0.7	1.2	V
Revers Recovery Time $I_F = 20A, V_{GS} = 0V,$ $dI_F/dt = 100A/\mu s \quad T_J = 25^\circ\text{C}$	T_{rr}		95		ns
Revers Recovery Charge $I_F = 20A, V_{GS} = 0V,$ $dI_F/dt = 100A/\mu s \quad T_J = 25^\circ\text{C}$	Q_{rr}		300		nC

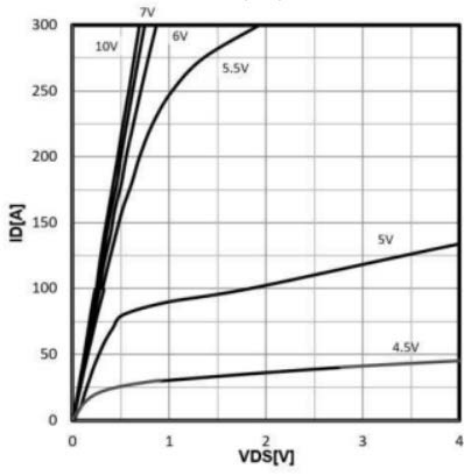


Figure 1. Typical output characteristics (Tj=25°C)

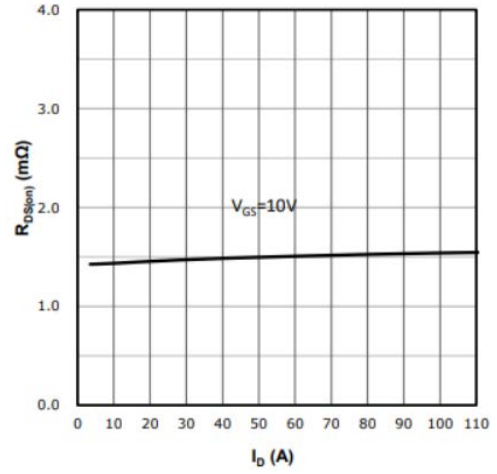


Figure 2. Typical Drain On-Resistance

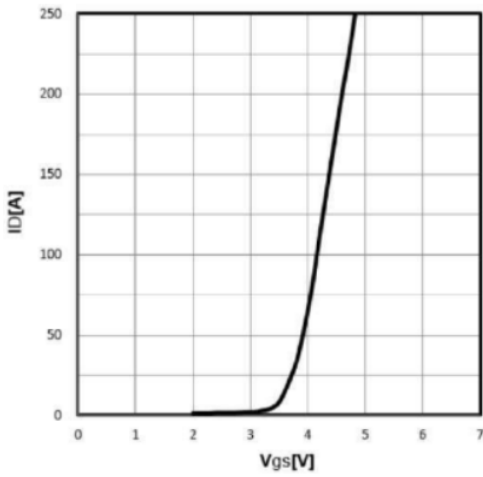


Figure 3. Typical Transfer Characteristics

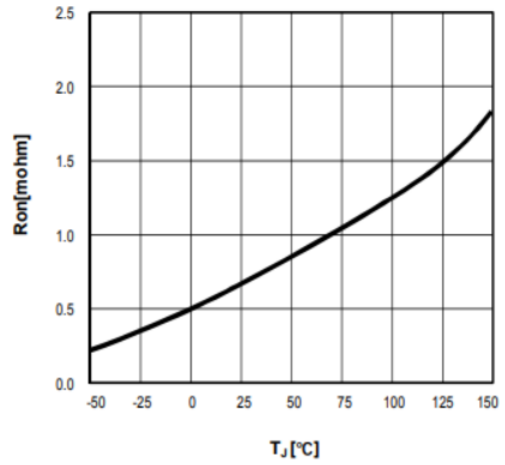


Figure 4. Drain-Source On-State Resistance
ID=50A , VGS=10V

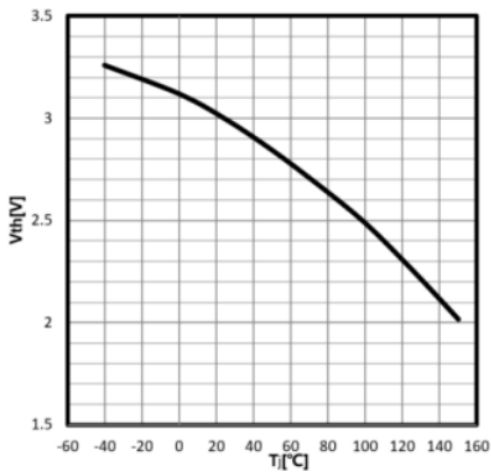


Figure 5. Gate Threshold Voltage
ID=250uA

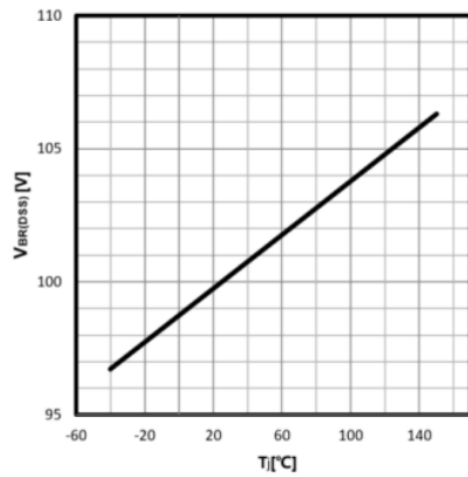


Figure 6. Drain-Source Breakdown Voltage
ID=250uA

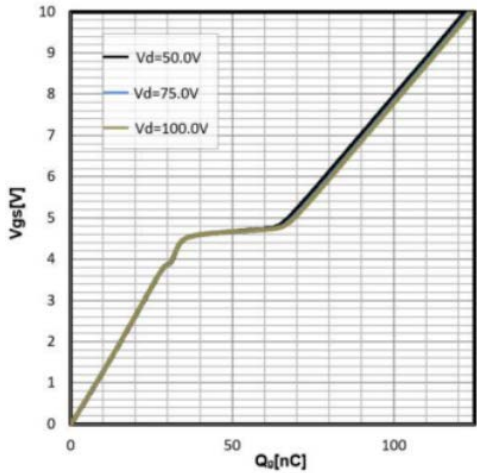


Figure 7. Typical Gate Charge
ID=20A

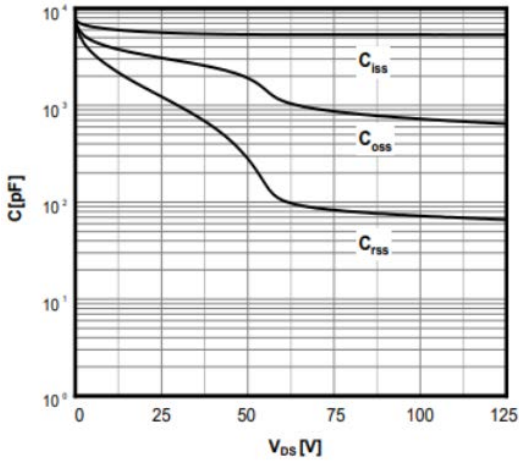


Figure 8. Typical Capacitances
VGS=0V, f=1MHz

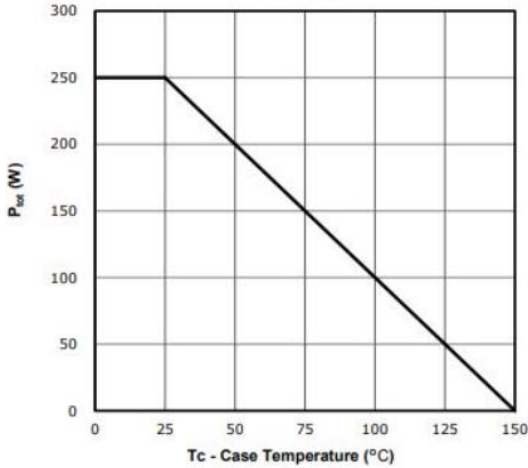


Figure 9. Power Dissipation

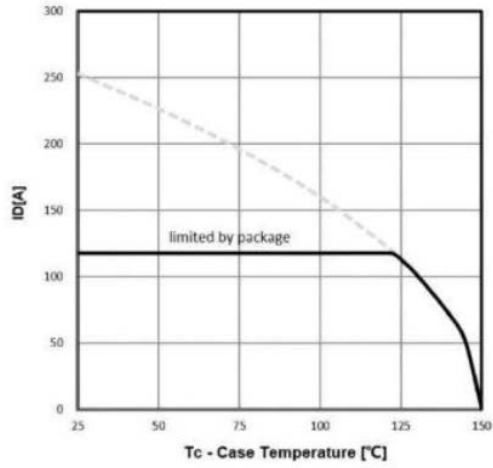


Figure 10. Max. Drain Current

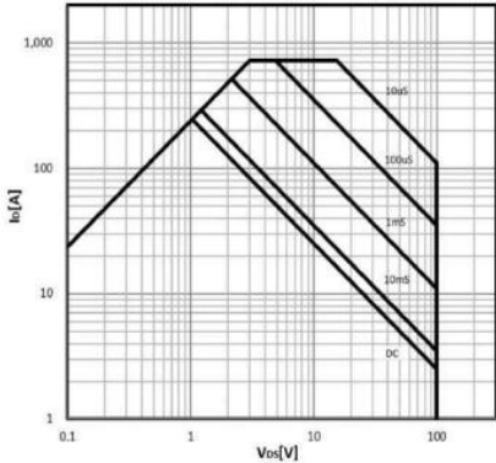


Figure 11. Safe Operating Area

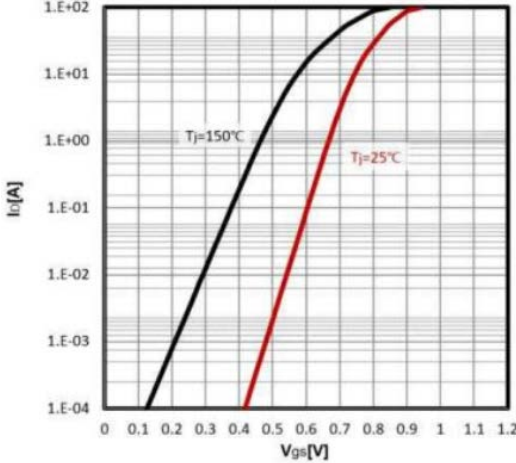


Figure 12. Body Diode Forward voltage variation

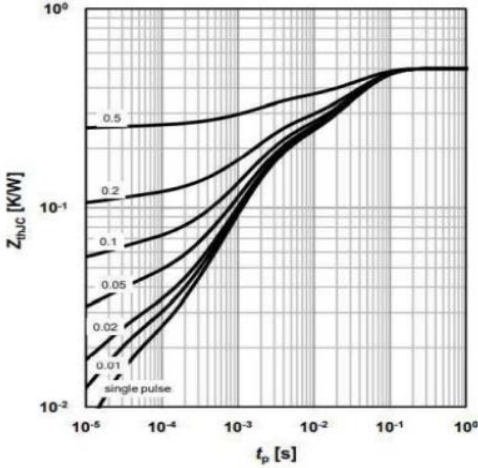
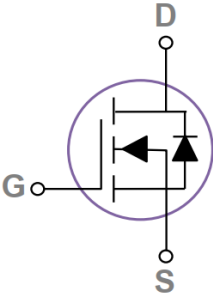
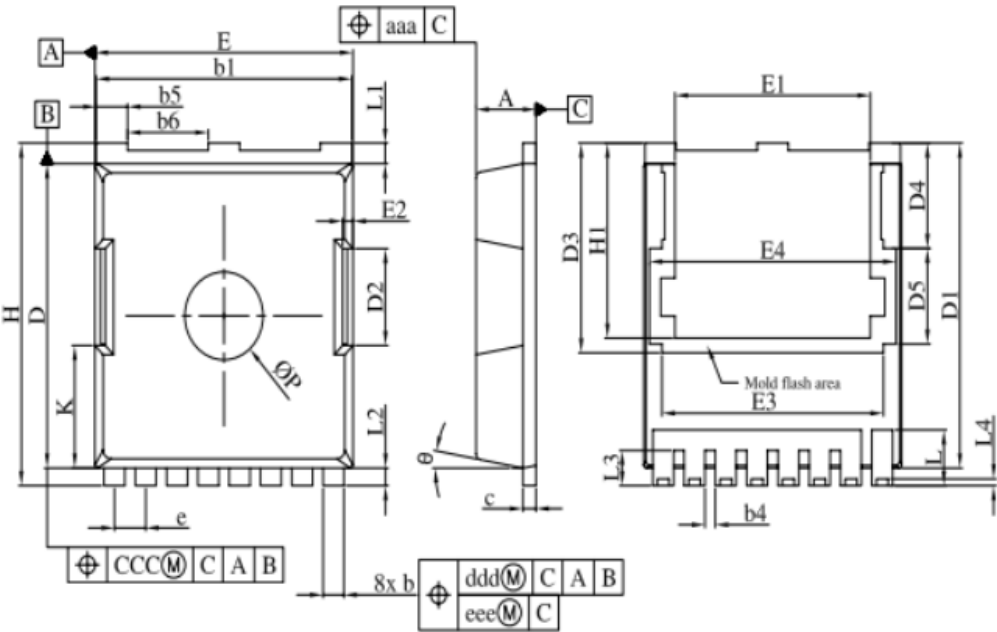


Figure 13. Max. Transient Thermal Impedence

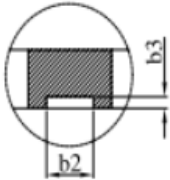
• Circuit diagram



• TOLL Package outlines : Dimensions in (mm)



SYMBOL	COMMON		
	MILLIMETER		
	MIN.	NOMINAL	MAX.
A	2.20	2.30	2.40
b	0.70	0.80	0.90
b1	9.70	9.80	9.90
b2	0.36	0.45	0.55
b3	0.05	0.100	/
b4	0.30	0.40	0.50
b5	1.10	1.20	1.30
b6	3.00	3.10	3.20
c	0.40	0.50	0.60
D	10.28	10.38	10.55
D1	10.98	11.08	11.18
D2	3.20	3.30	3.40
D3	7.15		
D4	3.59		
D5	3.26		
e	1.10	1.20	1.30
E	9.80	9.90	10.00
E1	7.40	7.50	7.60
E2	0.30	0.40	0.50
E3	8.50		
E4	9.46		
H	11.50	11.68	11.85
H1	6.55	6.65	6.75
K	4.08	4.18	4.28
L	1.60	1.90	2.10
L1	0.50	0.70	0.90
L2	0.50	0.60	0.70
L3	1.00	1.20	1.30
L4	0.13	0.23	0.33
P	2.85	3.00	3.15
θ	10° REF		
aaa	0.20		
ccc	0.20		
ddd	0.25		
eee	0.20		



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